



System-level qualification guidelines as a part of RHA procedure for accelerator applications

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Radiation environment at particle accelerators

High energy hadron equivalent fluence

30 40 50 60 distance from IP [m]

- LHC interaction points scattering from the organized particle collisions
- Interactions with beam-intercepting devices (collimators, magnets, absorbers)

20 15 10

5 X [m]

> -5 -10

-15 -20

10 20

Beam-gas interactions

The accelerator environment poses a serious challenge for the functionality assurance at CERN, especially in the case of the demanding requirements of the High-Luminosity LHC (0.1 dumps/fb⁻¹, 5x lower than during 2017)

80

90

70

100 fb⁻¹

/cm² 1

 10^{8}

 10^{6}



Particle collision at CMS experiment [1]









Radiation Hardness Assurance Procedures – current status at CERN





Initial version of RHA procedure was developed by S. Danzeca, R. Ferraro and G. Tsiligiannis (CERN BE-CEM-EPR), including the preliminary system-level testing guidelines Responsible sides fill in the RHAPV document [4]



RHAPV document



Central to the RHA procedure is the <u>RHAPV document</u> (Radiation Hardness Assurance Protocol), which is being completed on the course of the development process by:

- a. Group/section responsible for the project development
- b. R2E project
- c. RADWG (Radiation Working Group)
- d. MCWG (Monitoring and Calculation Working Group)

Main chapters:

Project description

Scope of the project, criticality and lifetime, installation location, etc.

Radiation environment definition

To be assessed by RADWG and MCWG

Radiation testing

- Component level test summary
- □ System-level test summary

Final summary

				Page 2 of 1
Radiation Ha	rdness Assul < <u> Equipme</u> Brief description Brief description Construction	rance Proto nt name > of the project(s) ption >	ocol Docur	ment
EQUIPMENT CONCERNED:	DRAWINGS CONCERNED:		DOCUMENTS CONCERNED:	
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Rejected.		Rejected.		
Accepted by the Project Engineer,		Accepted by the Project Leader.		
no impact on other items.				
Actions identified by the Project Engineer.				
Accepted by the Project Engineer,				
but impact on other items.				
Comments from other Project Engine	ers required.			
Final decision and actions by the Proj	ect Management.			
DATE OF APPROVAL:		DATE OF AP	PROVAL:	
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DATE OF IMPLEMENTATION: < D	ATE >			
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System-level testing as a part of the existing RHA guidelines: failure modes



Parameters to be monitored during tests are the system-level failure modes, which are determined by analyzing the device on the component, circuit and system level, and determining how SEEs can be propagated.

Failure Modes	Failure Causes	Metrics affected
Permanent loss of Functionality/Capability	TID/DD Failures Destructive SEE	System Reliability : Probability of meeting requirements at end of life
Temporary loss of Functionality/Capability	SEFI, spurious reset, etc.	System Availability
Information Integrity loss	SEU, MBU, stuck bits, SEFI	Example: Bit error rate, sample error rate, frame error rate
Performance Degradation	TID/DD	Examples: System speed, decreased resolution



System-level testing as a part of the existing RHA guidelines: proposed rules



- The expected TID and HEH fluence of the radiation environment considering the entire design lifetime shall be defined in the RAHPV document.
- □ Test conditions (System speed, voltage, temperature...) shall be worse or equivalent to the application.
- □ In-flux testing is mandatory, most of the failure modes cannot be detected with step-stress testing.
- The dose rate must be adjusted so that at the end of the irradiation the system has received at least up to the ionizing dose expected in the operation lifetime following the RDR specification.
- Operational parameters during the test shall comply with the maximum parameter degradation acceptable to ensure system operation in compliance with system performance requirements.
- The analysis of system failures resulting of non-destructive SEL should be performed with special care, by using an anti-latchup circuitry embedded in the system or control at the Power Supply software in order to estimate the failure rate.
- For system failures resulting of SET, SEU, MCU, SEFI and other soft errors, the maximum fault coverage should be targeted during testing, i.e., the system must pass through all the possible states that it would pass during normal operation.
- The availability of the system in its different operational modes and its main functionalities must be measured: If Mean Time Between Failure = MTBF, Mean Time To Recover = MTTR, Availability = MTBF/(MTBF+MTTR)
- □ All the numeric lines involving data transfer shall be monitored.
- □ If mitigation technics are implemented, the error rates shall be measured also before this mitigation processes in order to measure their performances.

System-level tests for CERN accelerator electronics should be carried out at the CHARM facility





A considerable amount of component-level radiation effects data are already gathered by R2E and available in the <u>RADWG database</u> (used at RHA phase 3). Tests are performed by following the established (device-specific) procedures.

System-level tests (RHA phase 4) remain the subject of interest considering that:

- substantial complexity of accelerator electronic systems makes component-level tests much less reliable if not supplemented by system-level ones;
- system-level tests are an important part of the RHA procedure, which cannot be complete without the relevant guidelines;
- The existing guidelines need revision and standardization (to be comparable with RADSAGA System-Level Testing Guideline for Space Systems)
- as electronics reliability is a part of the goals and mission of the R2E project at CERN, such an important aspect cannot be overlooked.







In the scope of the guidelines development, subjected to system-level tests are the electronic devices currently developed in R2E for the accelerator environment.

1. SEU tester v2 (target environment: CHARM facility)

Upgrade and modernization of the SEU tester v1 to include several useful features:

- on-board DUT supply voltage regulation
- □ logical level isolation for I/O lines
- DUT analog signal monitoring and others.

2. RadMon Detector Readout Module (target environment: LHC tunnel) Integration of a new module in the existing RadMon device:

- □ readout system for the semiconductor detectors to perform spectrometry in LHC tunel
- **a** adaptive readout frontend and power supply to accomodate different detector types



SEE Tester v2 (1)



A new version of SEE Tester was developed to increase the range of tested devices as well to implement features necessary for advanced testing (supply voltage regulation, ADC)

COTS components, predominantly tested by R2E, were used





SEE Tester v2 (2)

0 - 6V

8 - 30V



Main features:

- Based on Microsemi SmartFusion2 SoC
- □ Interfaces: Ethernet, RS-485, USB
- External 4Gb DDR3 SDRAM
 memory for data acquisition
- External and programmable (0 3,6V) voltage supplies for the DUT with power cycle possiblity
- DUT current consumption monitoring





SEE Tester – plans and timeline



Dedicated firmware project – June 2021

Device verification and electrical tests - August-September 2021

Preliminary system-level tests with radiation sources (e.g. Co-60) - October-November 2021

System-level tests at CHARM – 2022

Although most of the used electronic components have radiation effects data, the missing data should be completed in accordance with existing RHA sequence.





Thank you for your attention





[1] G. Lerner, "Accelerator radiation environment: modeling and monitoring tools and approaches", presentation, ISAE-SUPAERO EEOS-207, 3 June 2020

[2] R. Garcia Alia et al., "Direct Ionization Impact on Accelerator Mixed-Field Soft Error Rate", IEEE Transactions on Nuclear Science PP(99):1-1, November 2019, DOI:10.1109/TNS.2019.2951307

[3] R. Bartolini, "Electron beam dynamics in storage rings", presentation, John Adams Institute for Accelerator Science – Graduate Accelerator Physics Course, 12 November 2014

[4] Radiation hardness assurance project validation document (template), CERN EDMS no. 2028777